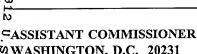
Case Docket No. ADTST.037AUS

Date: November 12, 2001 Page 1



SASSISTANT COMMISSIONER FOR PATENTS WWASHINGTON, D.C. 20231

ATTENTION: APPLICATION BRANCH

Sir:

Transmitted herewith for filing is the patent application of

Inventor(s): Michael Purtell et al.

For: EVENT BASED TEST SYSTEM HAVING IMPROVED SEMICONDUCTOR CHARACTERIZATION MAP

Enclosed are:

- (X) 5 sheet(s) of drawings.
- (X) 14 pages of specification, claims and abstract.
- UNSIGNED declaration and power of attorney.
- Return prepaid postcard.

CLAIMS AS FILED				
FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
Basic Fee			\$740	\$740
Total Claims	6 - 20 =	0 ×	\$18	\$0
Independent Claims	1 - 3 =	0 ×	\$84	\$0
If application contains any multiple dependent claims(s), then add \$280				\$0
	TOTAL FILING FEE			\$0

(X) A check in the amount of \$740 to cover the filing fee is enclosed.

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November 12, 2001

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ADTST.037AUS Attorney Docket No.

Michael Purtell et al. Applicant(s)

EVENT BASED TEST SYSTEM HAVING For

> IMPROVED **SEMICONDUCTOR**

CHARACTERIZATION MAP

Yasuo Muramatsu **Attorney**

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Transmittal; a patent application in 14 pages of specification and 5 sheets of drawings; a check of \$740 for filing fee; Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

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